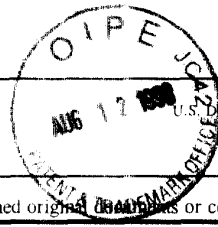


08-24-1998



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FORM PTO-1596
1-31-92

DOCKET NO.: LGS/K-057

PATENTS ONLY

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original or copy thereof.

1. Name of conveying party(ies): Hyeon-II LEE Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		2. Name and address of receiving party(ies): Name: <u>LG SEMICON CO., LTD.</u> Internal Address: Street Address: <u>1, Hyangjeong-dong, Heungduk-gu</u> City: <u>Cheongju-si</u> State/Country: <u>Chungcheongbuk-do, Korea</u> ZIP: 360-480 Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	
3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other Execution Date: <u>June 10, 1998.</u>			
4. Application number(s) or patent number(s): If the document is being filed together with a new application, the execution date of the application is: <u>June 10, 1998.</u> A. Patent Application No(s): Filed B. Patent No(s) Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No			
5. Name and address of party to whom correspondence concerning document should be mailed: Name: <u>FLESHNER & KIM</u> Internal Address: Street Address: <u>P. O. Box 221200</u> City: <u>Chantilly</u> State: <u>VA</u> ZIP: <u>20153-1200</u>		6. Total number of applications and patents involved: 7. Total fee (37 C.F.R. § 41) \$ <u>40.00</u> <input checked="" type="checkbox"/> Enclosed (Check No. <u>6082</u>) <input type="checkbox"/> Authorized to be charged to deposit account 8. Deposit account number: <u>16-0607</u>	
DO NOT USE THIS SPACE			
9. Statement and signature. <i>To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.</i> <div style="display: flex; justify-content: space-between;"> <div> <u>Carl R. Wesolowski, Reg. No. 40,372</u> Name and Registration No. of Person Signing </div> <div> Signature </div> <div> <u>August 12, 1998</u> Date </div> </div> <div style="text-align: right;"> Total number of pages including cover sheet: <u>2</u> </div>			

CMB No. 0851-0011 (exp. 4/94)

08/17/1998 BHINES 00000002 09094564

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40.00 BP

PATENT
REEL: 9393 FRAME: 0566

Docket No. LGS/K-057

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) Hyeon Il LEE (4) _____
(2) _____ (5) _____
(3) _____ (6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

LG Semicon Co., Ltd.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

LEAD FRAME AND SEMICONDUCTOR PACKAGE WITH SUCH LEAD FRAME

(a) for which an application for United States Letters Patent was filed on June 15, 1998, and identified by United States Serial No. _____ or

(b) for which an application for United States Letters Patent was executed on June 10, 1998

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred

SIGNED on the dates indicated aside our signatures
INVENTORS

DATE SIGNED

1) LEE Hyeon il
Name: Hyeon Il LEE

98.6.10

2) _____
Name: _____

3) _____
Name: _____

4) _____
Name: _____

5) _____
Name: _____